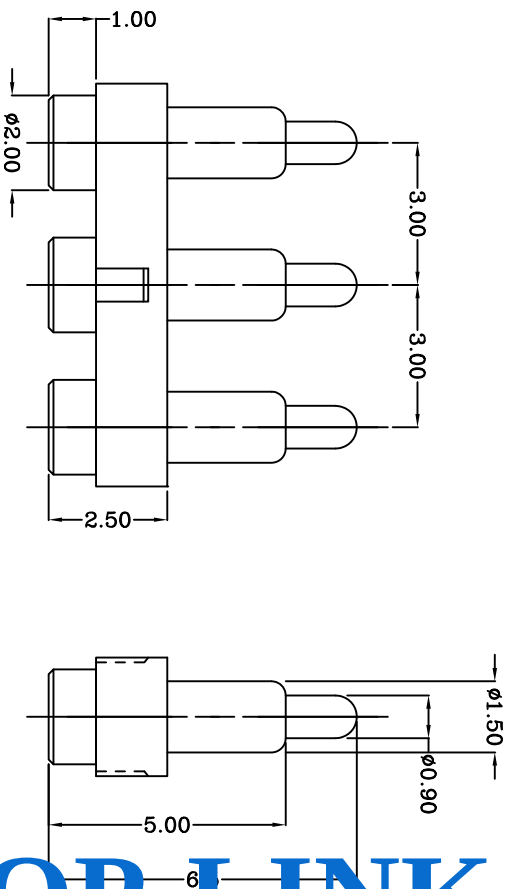
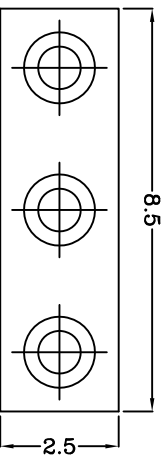
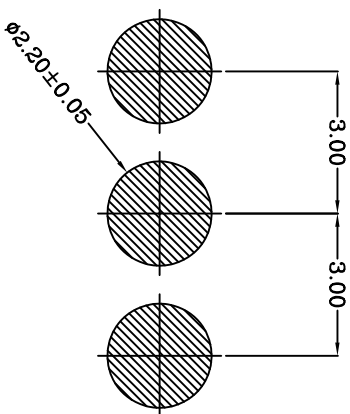


DWG NO.
C-110227



TOP-LINK



Recommended solder paste thickness is 0.10 mm

Notes:

1 Material, Housing: PA 4,6 (30% Glass Filled)
Color: Black.

2 Mechanical demands:

Plating Plunger: 0.4um Au over 1.4um Ni
Plating Body: 0.1um Au over 1.4um Ni.

LDC		HANDLE: 11		NAME		P0GD 3P	PGC-1.5-6.5-R-3P-3.0PH		
-		update remark		B007/18/21					
DIST		REVISION RECORD	APVD	DATE	SCALE	A4	DWG NO. C-110227	SHEET 1 OF 1	REV B
-					1:1				

DIMENSIONS IN MM TOLERANCES UNLESS OTHER SPECIFIED		MATH $\triangle$		HT TR —		FIN — ∇	
0	$\pm$	DYN		APVD	<i>Top-Link Electronics</i>	Top-Link Electronics Ltd.	
0.0	± 0.15	Benny		Lansing			
0.00	± 0.10	CHK		REL			
0.000	$\pm$	Andy					
ANGLE: 1°							
SURF. TEXTURE: $3.2/\sqrt{\text{in}}$		NAME PGGD 3P					
REMOVE BURS, BREAK SHARP EDGES R0.05 MAX		PGC-1.5-6.5-R-3P-3.0PH					
DO NOT SCALE PRINT		SCALE	A4	DWG NO. C-110227	SHEET 1 OF 1	REV B	

110227-3
PART NUMBER